

Bi-Directional N-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)		
30	0.019 at V _{GS} = 4.5 V	10.7		
	0.0195 at V _{GS} = 4.0 V	10.5		
	0.022 at V _{GS} = 3.1 V	9.9		
	0.027 at V _{GS} = 2.5 V	9.0		

FEATURES

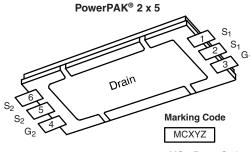
- Halogen-free
- TrenchFET® Power MOSFET: 2.5 V Rated
- ESD Protected: 3000 V



COMPLIANT

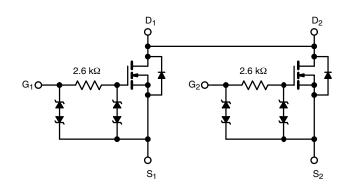
APPLICATIONS

- **Battery Protection Circuitry**
- 1-Cell Li-Ion Battery Pack
 - LiB/LiP
 - Lithium-Polymer



MC: Part # Code XYZ: Lot Traceability and Date Code

Ordering Information: SiF912EDZ-T1-GE3 (Lead (Pb)-free and Halogen-free)



ABSOLUTE MAXIMUM RATINGS T _A = 25 °C, unless otherwise noted						
Parameter		Symbol	10 s	Steady State	Unit	
Drain-Source Voltage		V _{DS}	30		٧	
Gate-Source Voltage		V _{GS}	± 12			
Continuous Drain Current /T 150 °C\d	T _A = 25 °C	- I _D	10.7	7.4	_	
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 85 °C		7.7	5.3		
Pulsed Drain Current (V _{GS} = 8 V, 10 μs)		I _{DM}	80		Α	
Continuous Diode Current (Diode Conduction) ^a		I _S	2.9	1.3		
Mariana Barra Biratiantian	T _A = 25 °C	- P _D	3.5	1.6	W	
Maximum Power Dissipation ^a	T _A = 85 °C		1.8	0.86	VV	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150		°C	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient ^a	t ≤ 10 s	R _{thJA}	30	36	°C/W
	Steady State		61	76	
Maximum Junction-to-Case (Drain)	Steady State	R _{thJC}	4.5	5.6	

a. Surface Mounted on 1" x 1" FR4 board.

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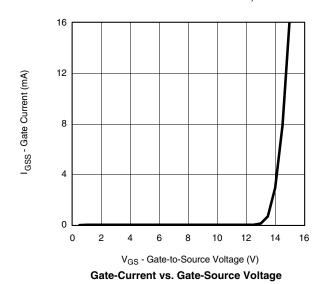
SPECIFICATIONS T _J = 25 °C, unless otherwise noted							
Parameter	Symbol	Test Conditions	Min. Ty		Max.	Unit	
Static							
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	0.6		1.5	٧	
Cata Dady Laglage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 4.5 \text{ V}$			± 10	: 10	
Gate-Body Leakage		$V_{DS} = 0 \text{ V}, V_{GS} = \pm 12 \text{ V}$			± 500		
Zero Gate Voltage Drain Current		V _{DS} = 30 V, V _{GS} = 0 V	0 V 1		1	μΑ	
	I _{DSS}	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 85 ^{\circ}\text{C}$			5	1	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} = 5 \text{ V}, V_{GS} = 4.5 \text{ V}$	40			Α	
		$V_{GS} = 4.5 \text{ V}, I_D = 7.4 \text{ A}$		0.0155	0.019	Ω	
	R _{DS(on)}	$V_{GS} = 4.0 \text{ V}, I_D = 7.3 \text{ A}$		0.016	0.0195		
Drain-Source On-State Resistance ^a		$V_{GS} = 3.1 \text{ V}, I_D = 6.8 \text{ A}$		0.018	0.022		
	-	$V_{GS} = 2.5 \text{ V}, I_D = 3.5 \text{ A}$		0.022	0.027		
Forward Transconductance ^a	9 _{fs}	V _{DS} = 10 V, I _D = 7.4 A		37		S	
Diode Forward Voltage ^a	V_{SD}	I _S = 2.9 A, V _{GS} = 0 V		0.75	1.1	٧	
Dynamic ^b							
Total Gate Charge	Q_{g}			9.8	15		
Gate-Source Charge	Q_{gs}	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 7.4 \text{ A}$		2.5		nC	
Gate-Drain Charge	Q _{gd}			2.9			
Turn-On Delay Time	t _{d(on)}			0.53	0.8		
Rise Time	t _r	$V_{DD} = 15 \text{ V}, R_{L} = 15 \Omega$		0.70	1.1	μs	
Turn-Off Delay Time	t _{d(off)}	$I_D\cong$ 1 A, V_{GEN} = 10 V, R_g = 6 Ω		8.0	12		
Fall Time	t _f			3.4	5		

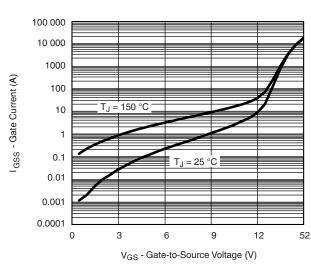
Notes:

- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





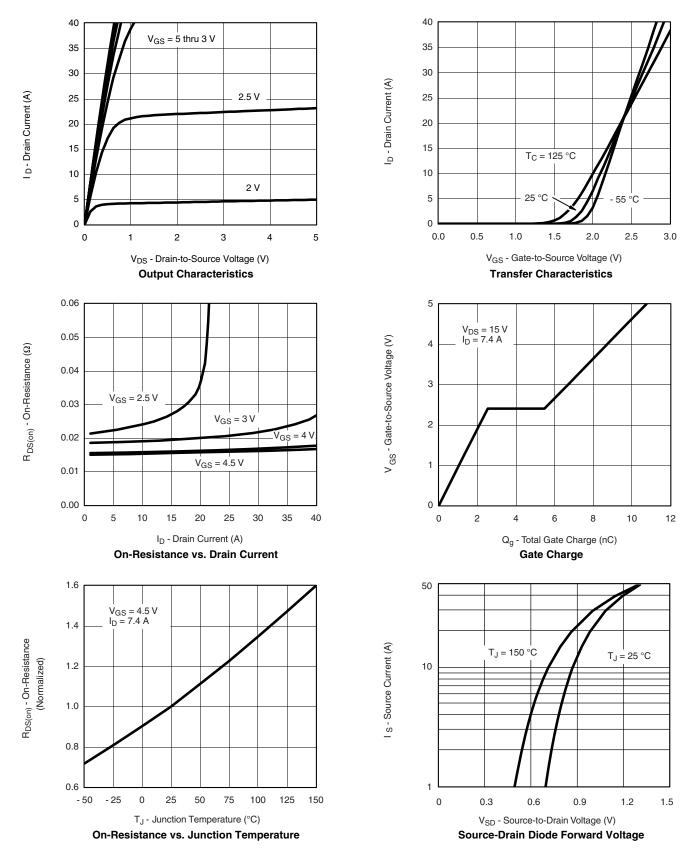
Gate Current vs. Gate-Source Voltage







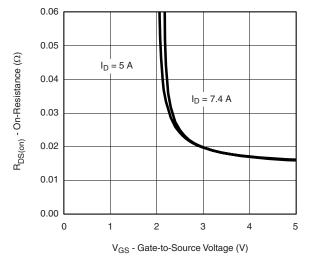
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



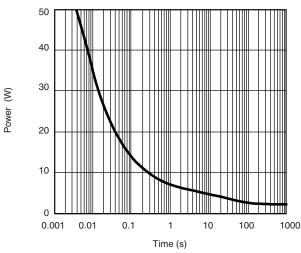
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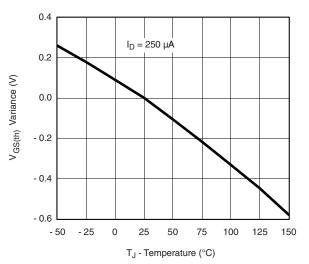
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



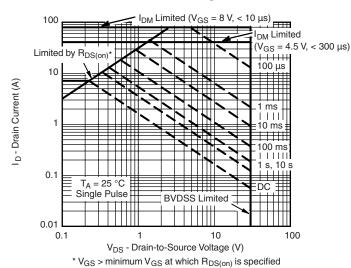
On-Resistance vs. Gate-to-Source Voltage



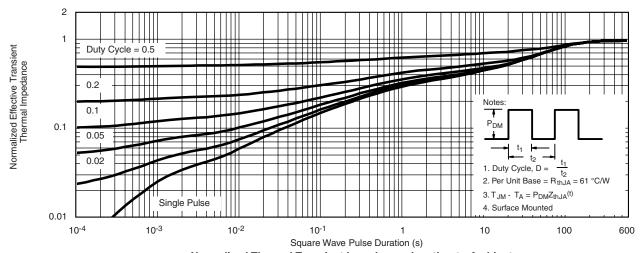
Single Pulse Power, Junction-to-Ambient



Threshold Voltage



Safe Operating Area

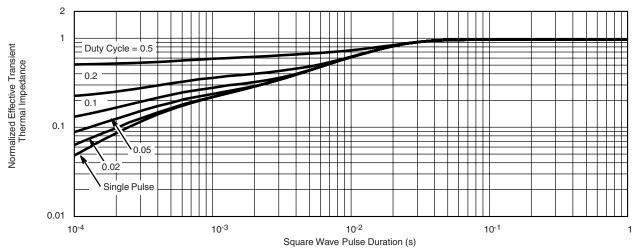


Normalized Thermal Transient Impedance, Junction-to-Ambient





TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Foot

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